5

4

DBV OR DCK PACKAGE (TOP VIEW)

А

GND 3

B 2

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I ∨<sub>CC</sub>

- *EPIC*<sup>™</sup> (Enhanced-Performance Implanted CMOS) Process
- Operating Range 2-V to 5.5-V V<sub>CC</sub>
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Package Options Include Plastic Small-Outline Transistor (DBV, DCK) Packages

### description

The SN74AHC1G08 is a single 2-input positive-AND gate. The device performs the Boolean function  $Y = A \bullet B$  or  $Y = \overline{\overline{A} + \overline{B}}$  in positive logic.

The SN74AHC1G08 is characterized for operation from -40°C to 85°C.

FU	FUNCTION TABLE									
INP	UTS	OUTPUT								
Α	В	Y								
н	Н	Н								
L	Х	L								
Х	L	L								

### logic symbol<sup>†</sup>



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram (positive logic)





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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$ Input voltage range, $V_{I}$ (see Note 1) Output voltage range, $V_{O}$ (see Note 1) Input clamp current, $I_{IK}$ ( $V_{I} < 0$ ) Output clamp current, $I_{OK}$ ( $V_{O} < 0$ or $V_{O} > V_{CC}$ ) Continuous output current, $I_{O}$ ( $V_{O} = 0$ to $V_{CC}$ ) Continuous current through $V_{CC}$ or GND Package thermal impedance, $\theta_{JA}$ (see Note 2): DBV package DCK package	$\begin{array}{ccc} -0.5 \ V \ to \ 7 \ V \\ \dots & -0.5 \ V \ to \ V_{CC} + 0.5 \ V \\ \dots & -20 \ mA \\ \dots & \pm 20 \ mA \\ \dots & \pm 25 \ mA \\ \dots & \pm 50 \ mA \\ \dots & 347^{\circ}C/W \\ \dots & 389^{\circ}C/W \end{array}$
Storage temperature range, T <sub>stg</sub>	

<sup>+</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.

#### recommended operating conditions (see Note 3)

			MIN	MAX	UNIT
Vcc	Supply voltage		2	5.5	V
	$V_{CC} = 2$		1.5		
VIH	High-level input voltage	$V_{CC} = 3 V$	2.1		V
		V <sub>CC</sub> = 5.5 V	3.85		
		$V_{CC} = 2 V$		0.5	V
VIL	Low-level input voltage	$V_{CC} = 3 V$		0.9	
	V <sub>CC</sub> = 5.5 V			1.65	
VI	Input voltage		0	5.5	V
Vo	Output voltage		0	VCC	V
		$V_{CC} = 2 V$		-50	μΑ
ЮН	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		-4	mA
	V <sub>CC</sub> = 5 V ± 0.5 V			-8	IIIA
		$V_{CC} = 2 V$		50	μΑ
IOL	Low-level output current $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$			4	mA
				8	IIIA
A+/A>-	Input transition rise or fall rate $\frac{V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}}{V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}}$			100	<b>n</b> o///
Δt/Δv				20	ns/V
ТА	Operating free-air temperature		-40	85	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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PARAMETER	TEST CONDITIONS	Vee	T <sub>A</sub> = 25°C				MAY	LINUT
FARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	WIIN	IVIAA	UNIT
		2 V	1.9	2		1.9		
	I <sub>OH</sub> = -50 μA	$\begin{tabular}{ c c c c c c c } \hline VCC & \hline MIN & TYP & MAX & MIN & MAX & UN \\ \hline $2V$ & 1.9 & 2 & 1.9 & & \\ \hline $3V$ & 2.9 & 3 & 2.9 & & \\ \hline $4.5V$ & 4.4 & 4.5 & 4.4 & & \\ \hline $3V$ & 2.58 & 2.48 & & \\ \hline $4.5V$ & 3.94 & 3.8 & & \\ \hline $4.5V$ & 3.94 & 0.1 & 0.1 & \\ \hline $3V$ & 0.1 & 0.1 & 0.1 & \\ \hline $3V$ & 0.1 & 0.1 & 0.1 & \\ \hline $4.5V$ & 0.1 & 0.1 & 0.1 & \\ \hline $4.5V$ & 0.36 & 0.44 & \\ \hline $4.5V$ & 0.36 & 0.44 & \\ \hline \end{tabular}$						
VOH		4.5 V	4.4	4.5		4.4	0.1 0.1 0.1 0.44 0.44	V
	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		
	I <sub>OH</sub> = -8 mA	4.5 V	3.94			3.8		
		2 V			0.1		0.1 0.1 0.1 0.44 0.44 ±1 10	
	I <sub>OL</sub> = 50 μA	3 V			0.1			
VOL		4.5 V			0.1		0.1	V
	I <sub>OL</sub> = 4 mA	3 V			0.36		0.44	
	I <sub>OL</sub> = 8 mA	4.5 V			0.36		0.44	
lj	$V_{I} = V_{CC} \text{ or } GND$	0 V to 5.5 V			±0.1		±1	μΑ
ICC	$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	5.5 V			1		10	μA
Ci	$V_{I} = V_{CC} \text{ or } GND$	5 V		4	10		10	pF

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	το ουτρυτ	T <sub>A</sub> = 25°C			MIN	MAX	UNIT			
FARAWETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX		WAA				
<sup>t</sup> PLH	A or B	Y	Y C <sub>L</sub> = 15 pF	X Curr	V		6.2	8.8	1	10.5	ns	
<sup>t</sup> PHL	AULP				6.2	8.8	1	10.5	115			
<sup>t</sup> PLH	A or B	V	$C_{\rm L} = 50  \rm pE$		8.7	12.3	1	14	-			
<sup>t</sup> PHL	AUB	Ť	ř	Y	Ŷ	C <sub>L</sub> = 50 pF		8.7	12.3	1	14	ns

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

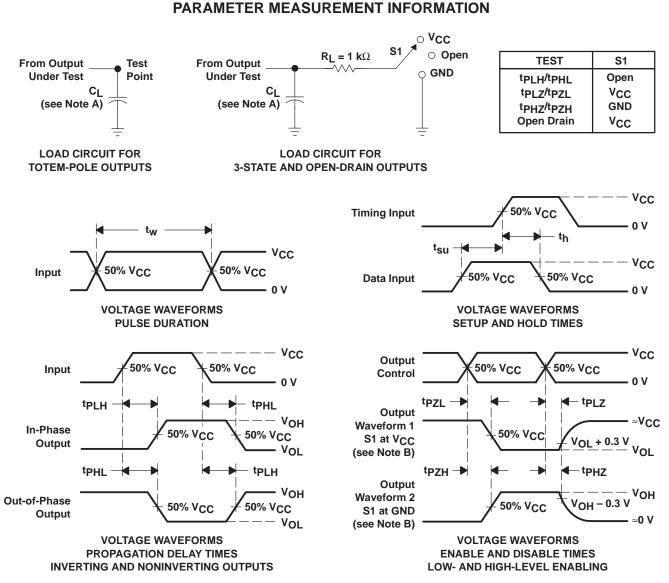
PARAMETER	FROM	TO (OUTPUT)	OUTPUT CAPACITANCE	T <sub>A</sub> = 25°C			MIN	мах	UNIT	
PARAMETER	(INPUT)			MIN	TYP	MAX				
<sup>t</sup> PLH	A or B	Y	Y C <sub>L</sub> = 15 pF	Ci – 15 pE		4.3	5.9	1	7	
<sup>t</sup> PHL	AUID				4.3	5.9	1	7	ns	
<sup>t</sup> PLH	A or B	V	$C_{\rm L} = 50  \rm pE$		5.8	7.9	1	9	-	
<sup>t</sup> PHL	AUIB	T	C <sub>L</sub> = 50 pF		5.8	7.9	1	9	ns	

## operating characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C

PARAMETER		TEST CO	ONDITIONS	TYP	UNIT
Cpd	Power dissipation capacitance	No load,	f = 1 MHz	18	pF



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NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  3 ns, t<sub>f</sub>  $\leq$  3 ns.

D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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